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# BLF6G20-230PRN; BLF6G20S-230PRN

**Power LDMOS transistor** 

**AMPLEON** 

Rev. 4 — 1 September 2015

Product data sheet

### 1. Product profile

### 1.1 General description

230 W LDMOS power transistor for base station applications at frequencies from 1800 MHz to 2000 MHz.

Table 1. Typical performance

RF performance at T<sub>case</sub> = 25 °C in a common source class-AB production test circuit.

Mode of operation	f	V <sub>DS</sub>	P <sub>L(AV)</sub>	Gp	η <sub>D</sub>	ACPR
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
2-carrier W-CDMA	1805 to 1880	28	65	17.5	32	-31 <mark>[1]</mark>

<sup>[1]</sup> Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7.5 dB at 0.01 % probability on CCDF per carrier; carrier spacing 5 MHz.

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

#### 1.2 Features and benefits

- Typical 2-carrier W-CDMA performance at frequencies of 1805 MHz and 1880 MHz, a supply voltage of 28 V and an I<sub>Dq</sub> of 2000 mA:
  - Average output power = 65 W
  - ◆ Power gain = 17.5 dB
  - ◆ Efficiency = 32 %
  - ◆ ACPR = -32 dBc
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (1800 MHz to 2000 MHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

## 1.3 Applications

■ RF power amplifiers for W-CDMA base stations and multi carrier applications in the 1800 MHz to 2000 MHz frequency range

## 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	e Graphic symbol
BLF6G20-2	230PRN (SOT539A)		
1	drain1		,
2	drain2	1 2	1 ┐ .ᆜ
3	gate1		5 3
4	gate2	3 4	5
5	source	<u>[1]</u>	4 7
			<u>'</u>
			2 sym117

BLF6G2	20S-230PRN (SOT539B)			
1	drain1			
2	drain2		1 2	1
3	gate1		5	, F
4	gate2		3 4	3 - 5
5	source	[1]		2 sym117

<sup>[1]</sup> Connected to flange

## 3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BLF6G20-230PRN	-	flanged balanced LDMOST ceramic package; 2 mounting holes; 4 leads	SOT539A		
BLF6G20S-230PRN	-	earless flanged balanced LDMOST ceramic package; 4 leads	SOT539B		

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	65	V
$V_{GS}$	gate-source voltage		-0.5	+13	V
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>case</sub>	case temperature		-	150	°C
Tj	junction temperature		-	225	°C

## 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{\text{th(j-case)}}$	thermal resistance from junction to case	T <sub>case</sub> = 80 °C; P <sub>L(AV)</sub> = 65 W	0.38	K/W

### 6. Characteristics

#### Table 6. Characteristics

 $T_i$  = 25 °C per section; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 1.8 \text{ mA}$	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$V_{DS}$ = 10 V; $I_{D}$ = 180 mA	1.4	1.9	2.4	V
I <sub>DSS</sub>	drain leakage current	V <sub>GS</sub> = 0 V				
		V <sub>DS</sub> = 28 V	-	-	3	μА
		V <sub>DS</sub> = 60 V	-	-	5	μА
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	30	-	Α
I <sub>GSS</sub>	gate leakage current	$V_{GS} = 11 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	300	nA
9 <sub>fs</sub>	forward transconductance	$V_{DS} = 10 \text{ V}; I_{D} = 9 \text{ A}$	-	12	-	S
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 6.3 A$	-	0.1	0.165	Ω

## 7. Application information

#### Table 7. Application information

Mode of operation: 2-carrier W-CDMA; PAR 7.5 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1 to 64 PDPCH;  $f_1$  = 1802.5 MHz;  $f_2$  = 1807.5 MHz;  $f_3$  = 1872.5 MHz;  $f_4$  = 1877.5 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 2000 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	$P_{L(AV)} = 65 \text{ W}$	16.3	17.5	18.7	dB
RLin	input return loss	$P_{L(AV)} = 65 \text{ W}$	-	-11	-6.5	dB
$\eta_{D}$	drain efficiency	$P_{L(AV)} = 65 \text{ W}$	29	32	-	%
ACPR	adjacent channel power ratio	$P_{L(AV)} = 65 \text{ W}$	-	-31	-27	dBc

#### Table 8. Application information

Mode of operation: 1-carrier W-CDMA; PAR 7.5 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1 to 64 PDPCH;  $f_1$  = 1872.5 MHz;  $f_2$  = 1877.5 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dg}$  = 2000 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
PARO	output peak-to-average ratio	P <sub>L(AV)</sub> = 125 W; at 0.01 % probability on CCDF	3.5	4.2	-	dB

### 7.1 Ruggedness in class-AB operation

The BLF6G20-230PRN and BLF6G20S-230PRN are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS} = 28 \text{ V}$ ;  $I_{Dq} = 2000 \text{ mA}$ ;  $P_L = 230 \text{ W}$  (CW); f = 1805 MHz.

### 7.2 Graphs

### 7.2.1 One tone CW

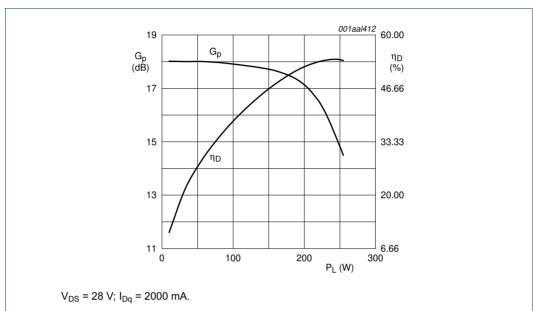
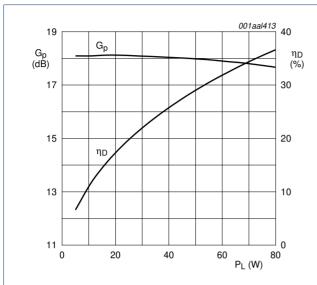


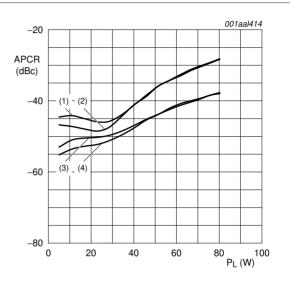
Fig 1. One-tone CW power gain and drain efficiency as functions of load power; typical values

#### 7.2.2 2-carrier W-CDMA



 $V_{DS} = 28 \text{ V}; I_{Dq} = 2000 \text{ mA}.$ 

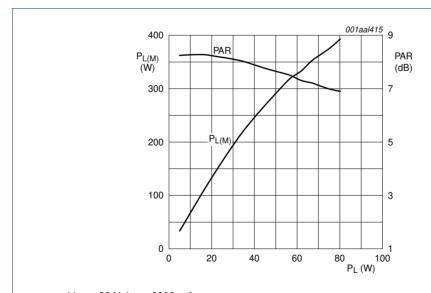
Fig 2. 2-carrier W-CDMA power gain and drain efficiency as functions of load power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 2000 \text{ mA}.$ 

- (1) f = 5 MHz low
- (2) f = 5 MHz high
- (3) f = 10 MHz low
- (4) f = 10 MHz high

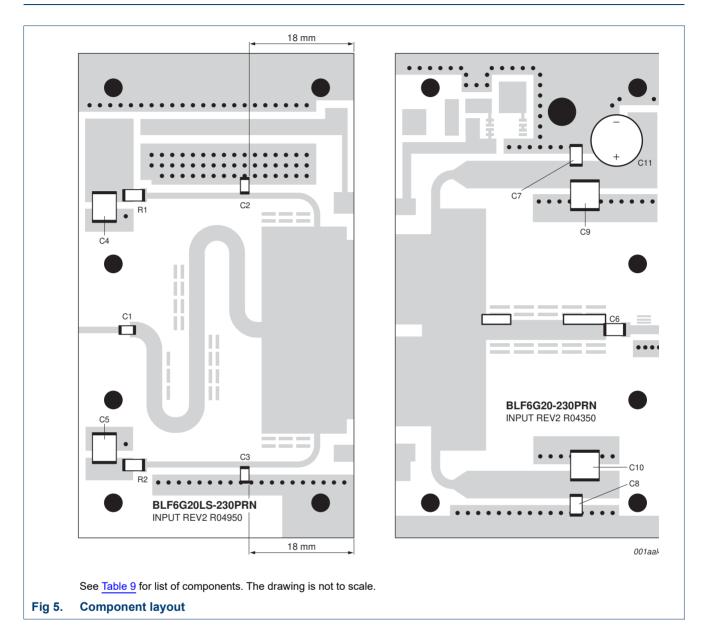
Fig 3. 2-carrier W-CDMA adjacent channel power ratio as function of load power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 2000 mA.

Fig 4. 2-carrier W-CDMA peak output power and output peak-to-average ratio as function of load power; typical values

## **Test information**



List of components See Figure 5 for component layout.

Component	Description	Value	Remarks
C1, C2, C3	multilayer ceramic chip capacitor	24 pF	ATC100A
C4, C5	multilayer ceramic chip capacitor	4.7 μF	TDK
C6	multilayer ceramic chip capacitor	33 pF	ATC8008
C7, C8	multilayer ceramic chip capacitor	12 pF	ATC100B
C9, C10	multilayer ceramic chip capacitor	10 μF	TDK
C11	electrolytic capacitor	220 μF/63 V	
R1, R2	SMD resistor	10 Ω	Philips 1206

BLF6G20-230PRN\_20S-230PRN#4

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## 9. Package outline

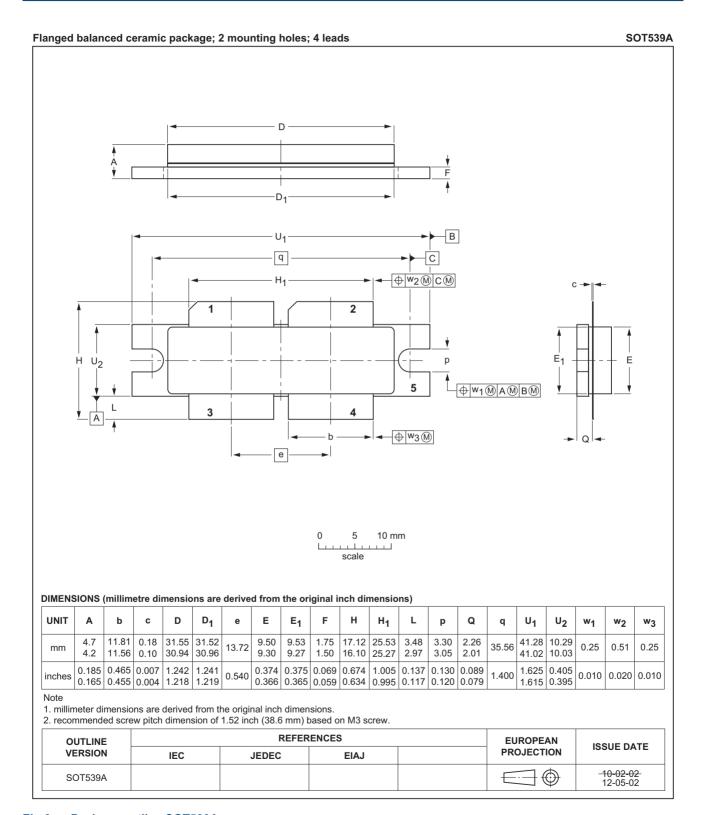


Fig 6. Package outline SOT539A

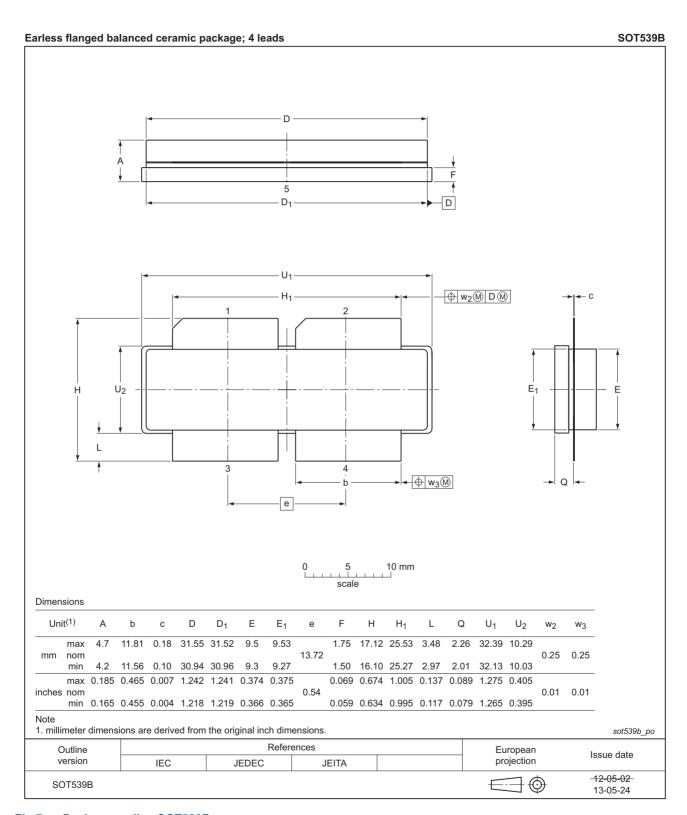


Fig 7. Package outline SOT539B

## 10. Abbreviations

Table 10. Abbreviations

Acronym	Description
3GPP	Third Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
DPCH	Dedicated Physical CHannel
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor
PAR	Peak-to-Average power Ratio
PDPCH	transmission Power of the Dedicated Physical CHannel
RF	Radio Frequency
W-CDMA	Wideband Code Division Multiple Access

## 11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLF6G20-230PRN_20S230PRN#4	20150901	Product data sheet	-	BLF6G20-230PRN_20S230PRN_V.3	
Modifications:	<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
BLF6G20-230PRN_20S230PRN_V.3	20130712	Product data sheet	-	BLF6G20-230PRN_20S230PRN_V.2	
BLF6G20-230PRN_20S230PRN_V.2	20100209	Product data sheet	-	BLF6G20-230PRN_1	
BLF6G20-230PRN_1	20081202	Objective data sheet	-	-	

## 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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## **BLF6G20(S)-230PRN**

**Power LDMOS transistor** 

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## **AMPLEON**

# **BLF6G20(S)-230PRN**

**Power LDMOS transistor** 

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